

applications

Performance and Scalability Enhancement

Wiwynn SV7220G3 Series features Intel® Xeon® Scalable Processors and the 2nd Generation Intel® Xeon® Scalable Processors. The latter provide pervasive performance enhancement including higher per-core performance and CPU frequency.

Enhanced Memory Performance

Compared with prior-gen processors, 2nd Generation Intel® Xeon® Scalable Processors increase memory speed and capacity, supporting up to 2933MHz memory speed and 16Gb-based DDR4 DIMMs. Wiwynn SV7220G3 Series is designed with 12 DIMM slots, with 16Gb-based DDR4 DIMMs support, SV7220G3 gets double system memory capacity up to 3TB.

Painless Upgrade for Machine Learning

The new feature of Intel® Deep Learning Boost (VNNI) empowers Wiwynn SV7220G3 to deliver significant and more efficient AI inference acceleration without hardware changes. With support of Intel® Optane™ DC persistent memory (AEP), data centers can utilize up to 512GB per DIMM for in-memory database, in-memory analytics or super-fast storage applications with affordable cost.

www.wiwynn.com



Three Wiwynn SV7220G3 servers in a 2OU (Open Rack) space

Designed for Optimized Energy Utilization with Computing Power

Inherit the vanity free concept of OCP, this new generation of 2U3Node computing server realized the commitment of OCP to minimize infrastructure power and cost by removing unnecessary components. Hence, the SV7220G3 gets significant 28~40% higher performance per watts than traditional design servers.

Various SKUs for Computing-intensive Applications

The high density 2U3Node architecture is approved by OCP having the optimized power efficiency is widely deployed in hyper-scale datacenters for computing-intensive applications. Wiwynn SV7220G3-S, the latest product based on this architecture, is your best choice. Another advanced model, SV7220G3-V series with four/two 2.5" drive trays offers enhanced I/O performance.



		SV7220G3-V	SV7220G3-V ⁺	SV7220G3-S	
SV7220G3 Series					
20	Form Factor, Processor, Memory and Chipset				
77	Form Factor	2U, Half width			
S	Processor	Intel® Xeon® Scalable Processors / Next Generation Intel® Xeon® Scalable Processors			
nn	Processor Sockets	Two per node (3 server nodes in a 2 OU shelf)			
Model: Wiwynn	Chipsets	Intel® C621 series • TPM 2.0			
?.	System Bus Intel® UltraPath Interconnect; 10.4GT/s				
<u>Jel</u>	Memory	Up to 3TB; DDR4 up to 2933MT/s; 12 DIMM slots			
400	Storage and I/O				
2	Storage	• Four SAS/ SATA HDD • To	wo SAS/ SATA HDD	· One 3.5" SAS/ SATA HDD	
	(hot-plug drive bay	· One M.2 SSD Module (Option on carrier card)			
	per node)				
	Expansion Slots	Two PCle x16 HHHL slots, On	ne PClex16 HHHL and	Two PCIe x16 FHHL slots	
		tw	o PClex8 HHHL slots		
		One OCP Mezzanine card (PCI-e x16) for:			
		• Single/Dual 10GbE DA/SFP+ ports (option)			
		· Single/Dual 25GbE SFP28 ports (option)			
	2016	· Single/Dual 40GbE QSFP ports (option)			
	BMC Chipset	ASPEED AST2500 with VGA			
	Remote	IPMI v2.0 Compliant, iKVM, Wiwynn Cluster Manager			
	Management LAN	One GbE Dedicated BMC port			
	Powers	108W (Idle); 330W (Max)			
	Power Supply, Physical and Packaging Specifications				
	Power Supply Centralized OCP Power Shelf Source For the result of Control Power Shelf (NO) v. 200 (D) v. 200				
	Form Factor and Dimensions	20U (Open Rack); 174 (W) x 880 (D) x 89 (H) (mm)			
	Weight	6.9 kg ~ 7.3 kg			
	OS				
	Support List	Support List RedHat Enterprise Linux 7.4			
		Ubuntu 18.0			

Wiwynn is a fast-growing cloud infrastructure provider that develops high-density computing and storage products, plus rack solutions for leading data centers.



